



B260S1F

2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C
60	2	0.65	0.2

Description and Applications

The schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD123F (Generic)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F (Generic)



Top View

Ordering Information (Note 4)

-			
	Part Number	Case	Packaging
	B260S1F-7	SOD123F (Generic)	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



B26 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 2 = February)



Date Code Kev

Year	2015	2016	2017	2018	2019	2020	2021	2022
Code	С	D	E	F	G	Н	I	J

		May Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code 1 2 3	4	5 6	7	8	9	0	N	D

B260S1F Document number: DS39237 Rev. 2 - 2



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	60	V
Average Rectified Output Current	Io	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	100	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	50	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V	_	0.55	0.65	\/	$I_F = 2A, T_J = +25^{\circ}C$
Forward Voltage Drop	V _F	_	0.52	_	V	I _F = 2A, T _J = +125°C
Lookogo Current (Note 6)		_	0.02	0.2	A	$V_R = 60V, T_J = +25^{\circ}C$
Leakage Current (Note 6)	IR	_	14	_	mA	$V_R = 60V, T_J = +125$ °C
Typical Capacitance	Ст	_	75	_	pF	$V_R = 4.0V$, $f = 1MHz$

Notes:

- 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad. 6. Short duration pulse test used to minimize self-heating effect.



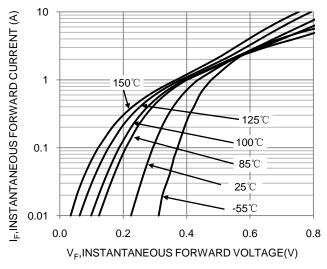


Figure 1. Typical Forward Characteristics

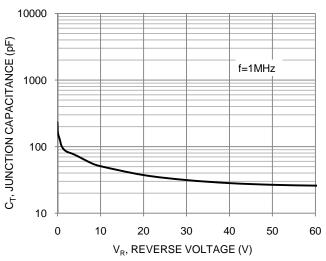


Figure 3. Typical Junction Capacitance

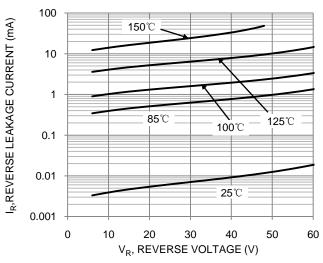


Figure 2. Typical Reverse Characteristics

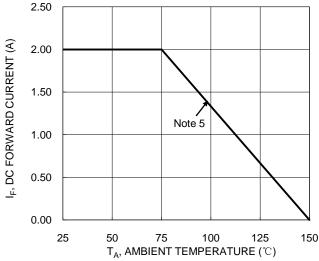


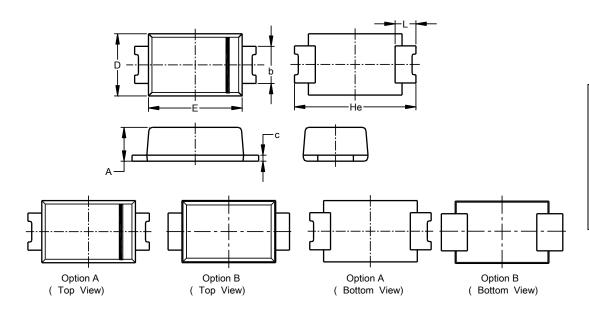
Figure 4. DC Forward Current Derating



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Generic)

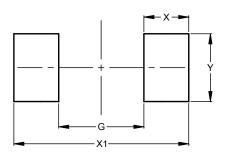


SOD123F (Generic)								
Dim	Min	Max	Тур					
Α	0.81	1.15	-					
b	0.80	1.35	-					
С	0.05	0.30	-					
D	1.70	1.90	1.80					
Е	2.60	2.80	2.70					
He	3.30	3.70	3.50					
L	0.35	0.85	-					
AII [Dimen	sions	in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Generic)



Dimensions	Value (in mm)
G	1.90
Х	1.00
X1	3.90
γ	1.50



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